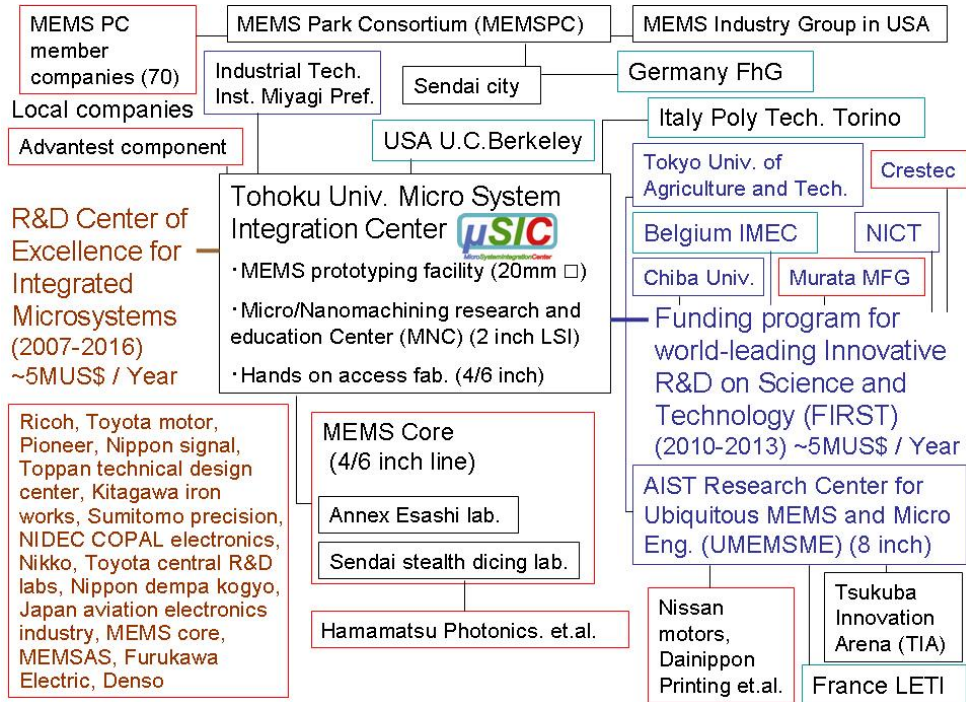
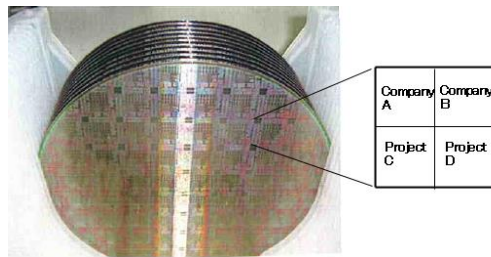


# Open collaboration and $\mu$ SIC



MEMS prototyping (20mm $\square$ wafer)



Shared wafer (16 companies)



Partnership between FhG and Sendai



MicroNanomachining Research & Education Center (MNC)



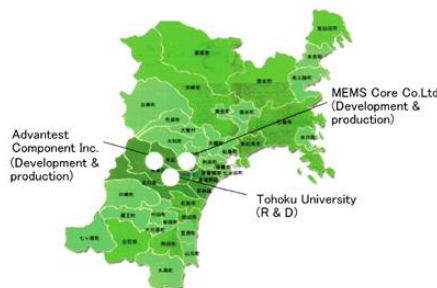
Micro System Integration Center ( $\mu$  SIC)



AIST Research Center for Ubiquitous MEMS and Micro Eng. (UMEMSME)



Advantest Component Inc.



MEMS Core Co. Ltd.